

SPECIFICATION

Customer: _____

Item: _____ Crystal Unit

Type: _____ NX3225GA

Nominal Frequency: _____ 40.000 MHz

Customer's Spec. No.: _____

NDK Spec. No.: _____ STD-CRA-1

Receipt

Revision Record						
Rev.	Date	Items	Contents	Approved	Checked	Drawn
---	18.Mar.2019	Issue	---	M.Sato	---	M.Harada

1. Customer's Spec. No. :
 2. NDK Spec. No. : STD-CRA-1
 3. Type : NX3225GA

4. Electrical Specifications

	Parameters	SYM.	Electrical Spec.				Notes
			min	typ	max	Units	
1	Nominal frequency	f_{nom}	40.000			MHz	
2	Overtone order	-	Fundamental			-	
3	Frequency tolerance	-	-50	-	+50	$\times 10^{-6}$	at +25°C
4	Frequency versus temperature characteristics	-	-150	-	+150	$\times 10^{-6}$	at -40~+150°C The reference temperature shall be +25°C
5	Equivalent resistance	-	-	-	100	Ω	IEC PI-network/Series
6	Load capacitance	C_L	-	8	-	pF	IEC PI-network
7	Level of drive	-	-	10	200	μW	
8	Operating temperature range	T_{opr}	-40	-	+150	°C	
9	Storage temperature range	T_{str}	-40	-	+150	°C	
10	Insulation resistance	-	500	-	-	M Ω	When terminal to terminal and terminal to cover were applied at DC100V $\pm 15V$.
11	Air-tightness	-	-	-	3.0×10^{-9}	Pa m ³ /s	Helium leak detector

5. Examination results document

The examination results document is submitted every shipment lot.

6. Application drawing

- 6.1 External dimension : EXD14B-00388
 6.2 Taping and reel figure : EXK17B-00247
 6.3 Holder marking : EXH11B-00392
 6.4 Reliability assurance Item : EXS30B-00396
 6.5 Recommendation reflow profile : EXS30B-00344

7. Notes on use

7-1 Even if the appearance color etc. of the product differs by purchasing the component parts by more than two companies, there is no influence on the characteristics and reliability.

7-2 IN THE CASE OF THE FOLLOWING ITEMS, WE ARE NOT RESPONSIBLE FOR WARRANTY / COMPENSATION.

(1) WHEN PRODUCTS OF THIS SPECIFICATION ARE USED FOR EQUIPMENT RELATED TO HUMAN LIFE OR PROPERTY, IT IS THE RESPONSIBILITY OF THE CUSTOMER TO CONFIRM THE INFLUENCE ON THIS PRODUCT AND EQUIPMENT TO BE USED BEFOREHAND, CONDUCT NECESSARY SAFETY DESIGN (INCLUDING REDUNDANT DESIGN, MALFUNCTION PREVENTION DESIGN, etc.), AND PLEASE USE IT AFTER SECURING SUFFICIENT SAFETY OF EQUIPMENT.

1. SAFETY-RELATED EQUIPMENT SUCH AS AUTOMOBILES, TRAINS, SHIPS, etc., OR EQUIPMENT DIRECTLY INVOLVED IN OPERATION
2. AIRCRAFT EQUIPMENT
3. SPACE EQUIPMENT
4. MEDICAL EQUIPMENT
5. MILITARY EQUIPMENT
6. DISASTER PREVENTION / CRIME PREVENTION EQUIPMENT
7. TRAFFIC LIGHT
8. OTHER EQUIPMENT REQUIRING THE SAME PERFORMANCE AS THE ABOVE-MENTIONED EQUIPMENT

(2) IN CASES WHERE IT IS NOT INDICATED IN THE REQUESTED STANDARD AND IS USED UNDER CONDITIONS OF USE (INCLUDING CIRCUIT MARGIN etc.) THAT CAN NOT BE PREDICTED AT THE PRODUCTION STAGE.

(3) WHEN USING ULTRASONIC WELDING MACHINE. (THERE IS A POSSIBILITY THAT THE CHARACTERISTIC DEGRADATION IS CAUSED BY THE RESONANCE PHENOMENON OF THE PIEZOELECTRIC MATERIAL.

(EXAMPLE; CRYSTAL PIECE))

WE WILL NOT TAKE ANY RESPONSIBILITY FOR THE INFLUENCE OF THE CUSTOMERS' PROCESS.

SO, PLEASE SUFFICIENTLY EVALUATE AT A SAMPLE STEP WHEN YOU USE ULTRASONIC WELDING MACHINE.

(4) USING RESIN MOLD MAY AFFECT THE PRODUCT CHARACTERISTIC.

PLEASE MAKE SURE TO TELL OUR SALES CONTACT WHEN YOU USE RESIN MOLD. WE WILL PERFORM INDIVIDUAL CORRESPONDENCE ABOUT A DELIVERY SPECIFICATION AND AN EVALUATION METHOD.

IN ADDITION, IF YOU USE RESIN MOLD WITHOUT CONTACTING US, AND CAUSES DAMAGES AGAINST A CUSTOMER OR A THIRD PARTY, WE WILL NOT BE LIABLE FOR THE DAMAGES AND OTHER RESPONSIBILITIES BECAUSE WE CONSIDER IT IS UNDER SELF-RESPONSIBILITY USING RESIN MOLD.

WE WILL NOT TAKE ANY RESPONSIBILITY FOR THE INFLUENCE OF THE CUSTOMERS' PROCESS. PLEASE SUFFICIENTLY EVALUATE AT A SAMPLE STEP WHEN YOU USE RESIN MOLD.

(5) WHEN PERFORMING IMPROPER HANDLING THAT EXCEEDS THE GUARANTEED RANGE.

8. Notes on storage

8-1 When storing the product in high temperature and high humidity condition for a long time, product characteristics (solderability etc.) and packaging condition may be deteriorated. Please store product at temperature + 5°C ~ + 35°C, humidity 85% RH or less. The product is an electronic component, so please do not storage and use, under a dewing state.

8-2 The product storage deadline is 12 months after delivery in unopened state. Please use within storage deadline. If you exceed storage deadline, please check the product characteristics etc, please use.

9. Other Requests

9-1 Please use this specification only for confirmation of the specification of this product.

9-2 If there is a change request, please contact within three weeks from issue date. If there is no communication, we will deliver the product under the contents of this specification. In addition, if the product delivery date is within 3 weeks and there is a change request, we will consult the processing separately.

9-3 NOTES THAT ARE DESCRIBED IN THIS DOCUMENT, IF YOU DID NOT COMPLY WITH THE PROHIBITIONS, AND OTHER PLEASE, INCLUDING THE FAILURE CORRESPONDENCE OR COMPENSATION OR DAMAGES, WE CAN NOT ASSUME THE RESPONSIBILITY, PLEASE UNDERSTAND.

10. Prohibited items

Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

(1) Reflow soldering heat resistance

Peak temperature: 265°C, 10 sec

Heating: 230°C or higher, 40 sec

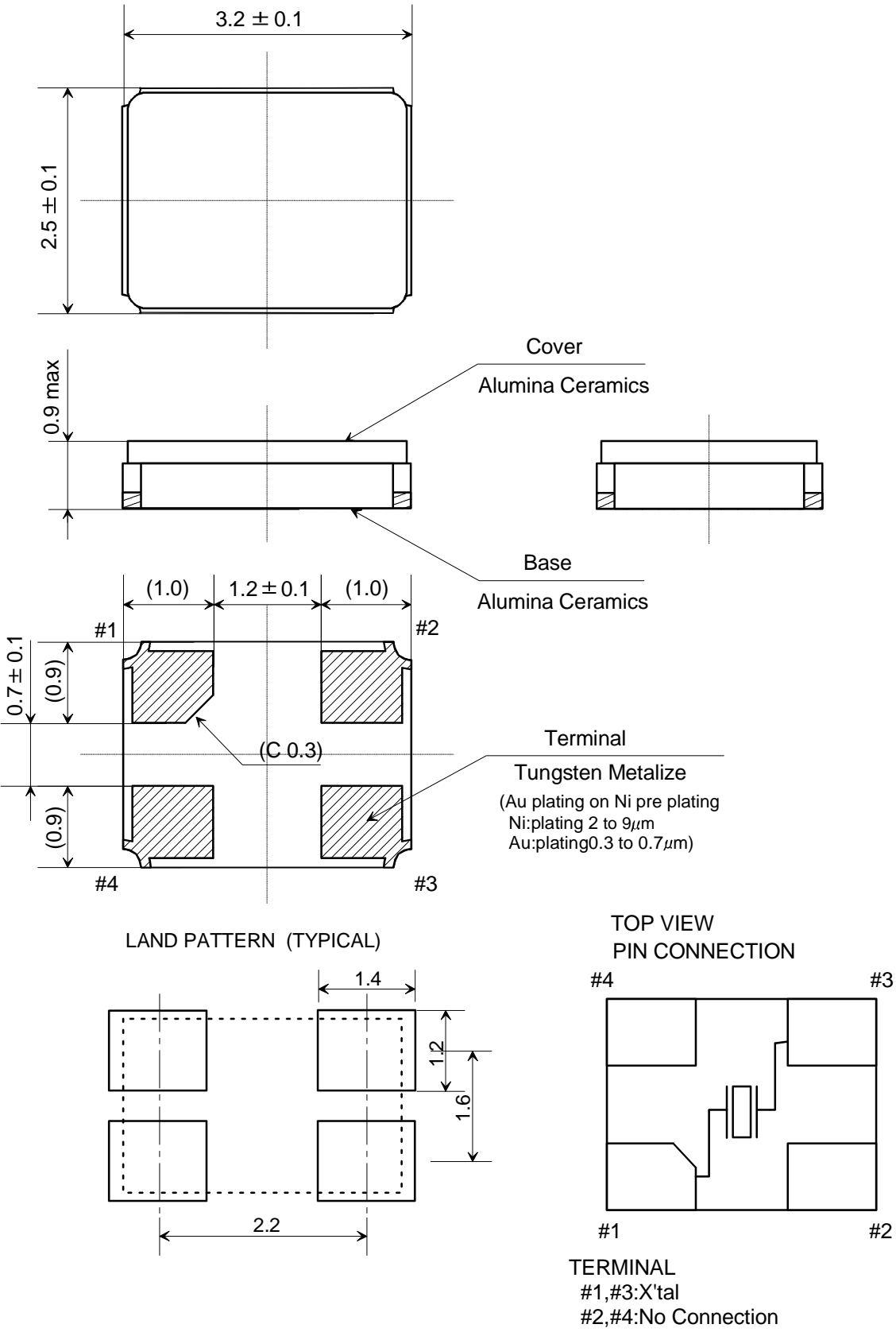
Preheating: 150°C to 180°C, 120 sec

Reflow passage times: twice

(2) Manual soldering heat resistance

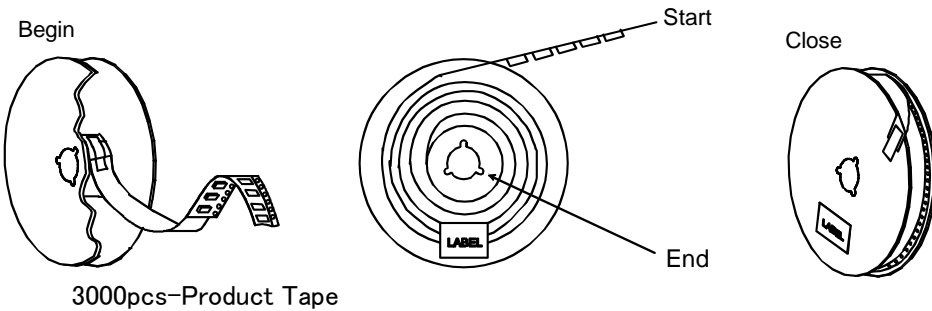
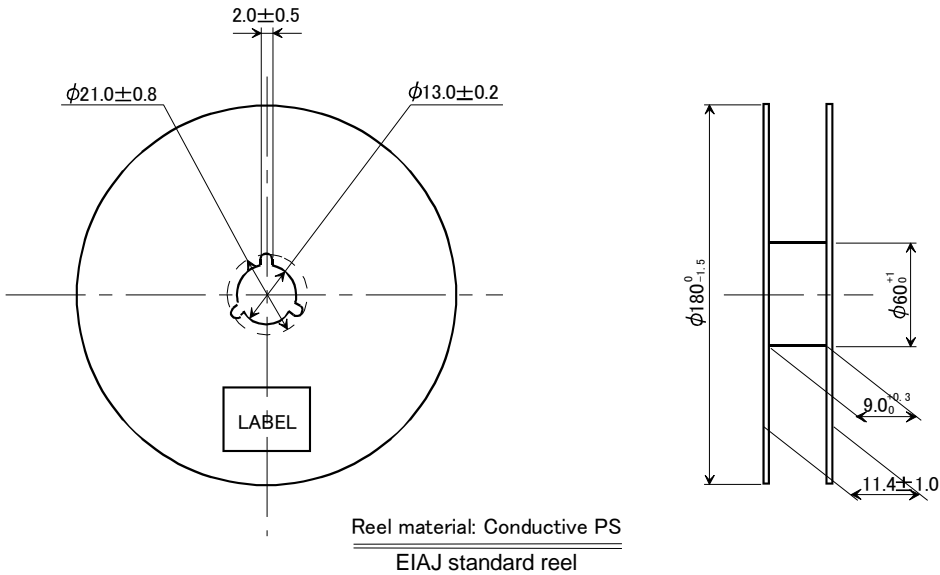
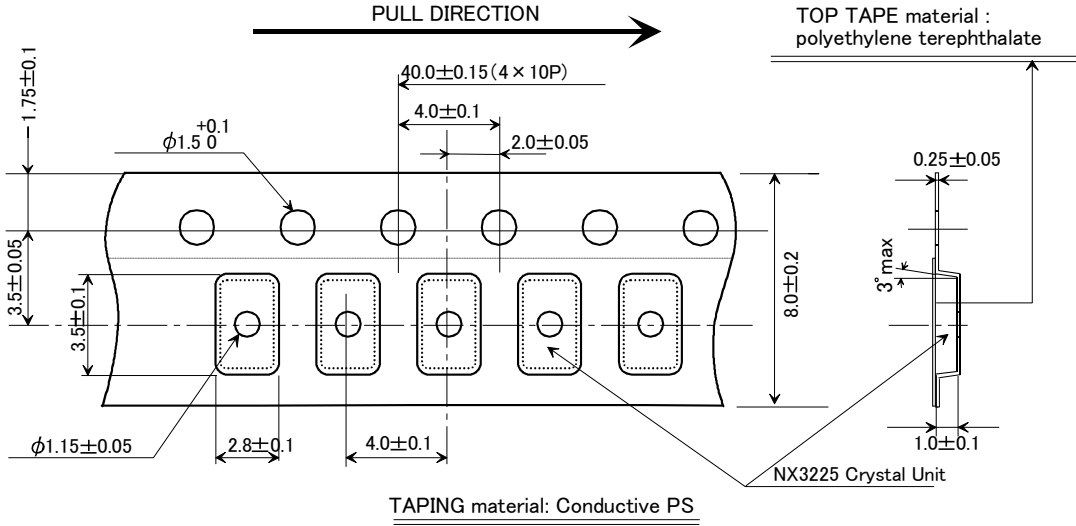
Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).

When using a soldering iron, press its tip on the part below the sealed part, avoiding the glass-sealed part (otherwise, the glass will melt and air-tightness may be lost)



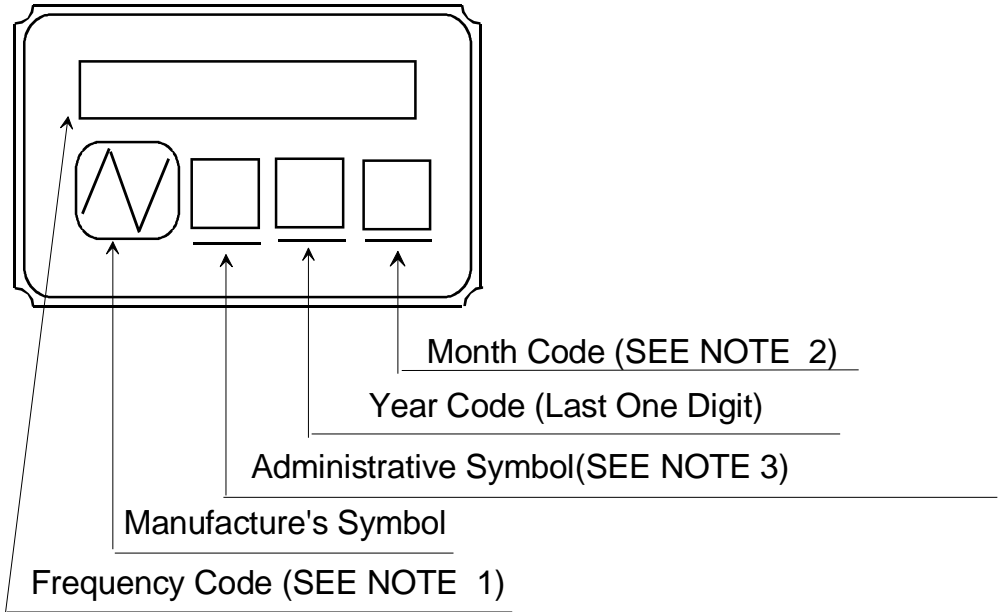
	Date of Revise	Charge	Approved	Reason
A	19.Jan.2018	M.Harada	H.Kobayashi	Add standard tolerance and change terminal C dimension to reference.
	Date	Name	Third Angle Projection	Tolerance
Drawn	30.Jun.2006	H.Yagishita	Dimension:mm	± 0.1
Designed	30.Jun.2006	H.Yagishita	Title	Drawing No.
Checked	30.Jun.2006	K.Kubota		
Approved	30.Jun.2006	T.Ishii		
			NX3225GA Dimension Drawing	EXD14B-00388
				Scale
				- / -
				Rev.
				A

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	Date of Revise	Charge	Approved	Reason	
A	26 Mar. 2013	T. Shimizu	K. Oguri	The appearance of a drawing was corrected.	
Drawn	Date	Name	Third Angle Projection	Tolerance	
30.Jun.2006	H.Yagishita	Dimension:mm	---	Scale	
Designed	30.Jun.2006	H.Yagishita	Title	Drawing No.	
Checked	30.Jun.2006	K.Kubota			EXK17B-00247
Approved	30.Jun.2006	T.Ishii			
			NX3225 Series Taping and Reel Spec.	B	

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NOTE
1. Frequency Code

Marking Frequency is consist of five digits, first five digits of Nominal Frequency

Example

Nominal Frequency	28.636363 MHz
Frequency Code	28.636

2. Month Code Table

Month	1 Jan.	2 Feb.	3 Mar.	4 Apr.	5 May.	6 Jun.	7 Jul.	8 Aug.	9 Sep.	10 Oct.	11 Nov.	12 Dec.
Month Code	1	2	3	4	5	6	7	8	9	X	Y	Z

3. Marking contents

Example

Administrative symbol	S
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*Marking digits are not include a decimal point and dot mark.

	Date of Revise	Charge	Approved	Reason		
	Date	Name	Third Angle Projection	Tolerance	Scale	
Drawn	19.May.2008	R.Shariman	Dimension:mm		/	
Designed	19.May.2008	R.Shariman	Title Crystal Holder Marking	Drawing No. EXH11B-00392	Rev.	
Checked	19.May.2008	M.Harada				
Approved	19.May.2008	K.Kubota				

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Reliability assurance item

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No.	Test item	Test methods	Spec. code
1	Drop	Devices are dropped from the height 75 cm onto iron plate. Execution 3 times random drops.	A
2	Shock	Acceleration: 49000 m/s ² Duration: 0.15 ms Half-Sine pulse 1 Shocks in 6 mutually perpendicular planes, Total 6 shocks	A
3	Vibration	Frequency range: 10 to 2000 Hz Amplitude or Acceleration: 1.52 mm or 196 m/s ² Sweep time: 20 min Test time: 4 h × 3	A
4	Electrode adherent strength	See remark (1)	B
5	Solderability	Pre-heat temperature : 150 °C Pre-heat Time : 60 ~ 120 s Peak temperature : 240 ± 5 °C 215 °C Over time : 10 ~ 30 s	C
6	Resistance to soldering heat	Pre-heat temperature : 150 °C Pre-heat time : 60 ~ 120 s Test temperature : 260 ± 5 °C Test time : 10 ± 1 s	A,B
7	Resistance to cold	Leave at -40 ± 2 °C for 1000 h	A
8	Resistance to heat	Leave at +150 ± 2 °C for 1000 h	A
9	Humidity	Device are left in temperature at +85 ± 2 °C with relative humidity of 80~85 % for 1000 h	A,D
10	Thermal shock	<p>Device are left into the following temperature cycle as shown in (Figure1) for 1000 consecutive cycle.</p> <p>(Figure1)</p>	A,B

Reliability assurance item

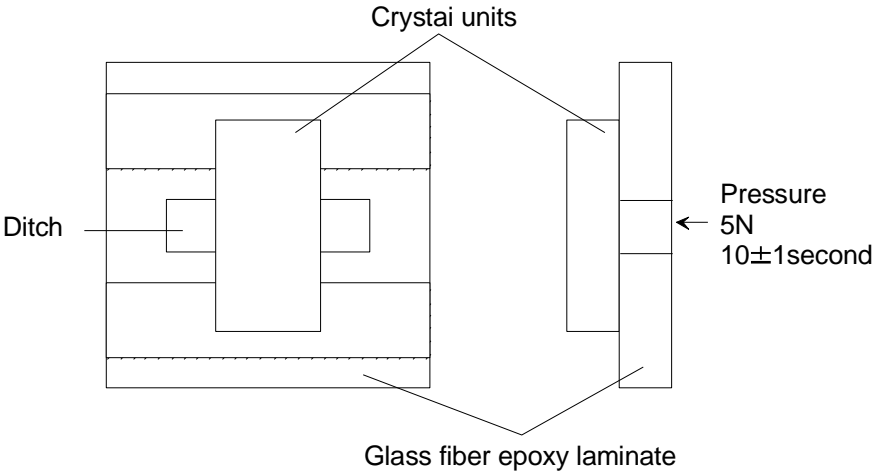
(page: 2/2)

Spec. code	Specification
A	Frequency tolerance and series resistance should be cleared.
B	After testing unless cracking of materials view of eyes and unless break of seal.
C	The leads shall acquire a new solder coat cover at 90 % of immersed area.
D	Insulation resistance shall be greater than 500 MΩ

Remark (1) Electrode adherent strength.

1) Test method condition

Using the solder, soldering Iron or reflow soldering bath shall be used for soldering on test fixture (Glass fiber epoxy laminate : Thickness 1.6mm+/-0.2mm) shown below.



2) Specified value

No peel of electrode, no crack, no other abnormality

Recommendation reflow condition

1.IR reflow condition

